

30 April 2024

YEUNG Ka Sing (Authorized Person)
c/o Ben Yeung & Associates Ltd.
Rm C, 1/F, Easy-pack Ind. Building
140 Wai Yip Street, Kowloon

WONG Ha (Registered Structural Engineer)
c/o GBA Consulting
Room 722, 7/F, Liven House
61-63 King Yip Street, Kwun Tong, Kowloon

Dear Sir / Madam,

Application for In-principle Acceptance of Modular Integrated Construction (MiC)
System Description: 睿住MiC REMAC SPACE MiC
(Model Number: RS-MiC No.A)
Applicant: 珠海市睿住建築科技有限公司

I refer to the application for in-principle acceptance (IPA) of the captioned MiC system and your submission received on 27 March 2023 and subsequent supplementary information last received on 21 March 2024.

The MiC system has been assessed through curtailed check on your submission plans, calculations, supporting documents and test reports, and is found in principle acceptable for the use in private building projects in Hong Kong subject to the conditions stipulated in the IPA letter issued to the applicant today.

You are reminded that the curtailed check of this Department covers only the fundamental issues of a building proposal. In this connection, I ask you to note that Buildings Department attaches great importance to the proper assumption of duties and responsibilities by authorized persons and registered structural engineers.

One set of the submission plans on which I have stamped to signify the IPA, and a copy of the IPA letter issued to the applicant are enclosed. I would request that you ensure the contents are understood by him.

/Should ...

Should you have any further questions, please feel free to contact Ms. TONG Fung-ling, Fiona at telephone no. 3842 3453 or Mr. TZE Chung-hon, Alfred at telephone no. 3842 3472 for discussion. For structural matters, you may wish to contact Ms. LIAUW Hak-ka, Carol at telephone no. 3842 3507 or Mr. KWONG Wai-hou, Vincent at 3842 3474 direct.

Yours faithfully,



(CHAN Wai-tong, Victor)
Chief Officer/Technical Services
for Director of Buildings

c.c. Applicant - 珠海市睿住建築科技有限公司
珠海市橫琴新區福臨道55號1205辦公-02
(Attn: 廖冬輝先生)

BD/MiC/230304 (S)